

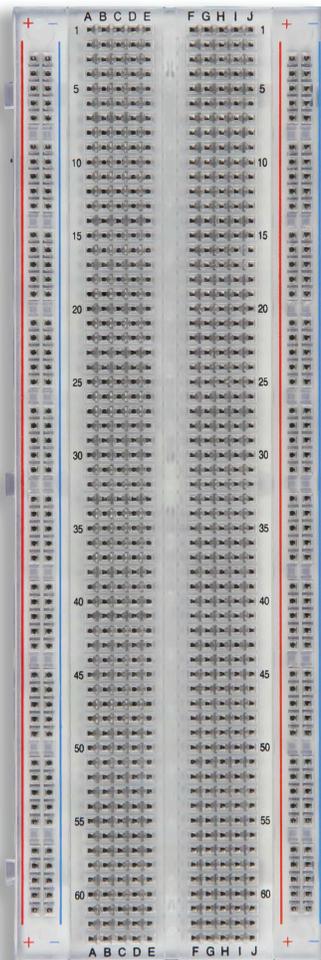
# GS-830T

## 830T TIE-POINT, SOLDERLESS BREADBOARD WITH BUS STRIP

### Applications

The GS-830T is a modular type solderless breadboard that is comprised of the GS-100T bus strip and the GS-630T breadboard. It is a great way to prototype low frequency or DC powered circuits. They are ideal for:

- Educational labs
- Hobbyists



### Features

- 830T Tie-points
- Transparent ABS plastic body
- Square hole style
- Interlocking tabs
- Peel and stick adhesive
- Nickel plated phosphor bronze spring clip contacts
- Allowable wire diameter of 0.4-0.7 mm
- Fits 7 total 16-pin ICs
- Measures 6.5 x 2.125 x 0.33 in
- Maximum capacity of 1.5 A at 36 V
- RoHS compliant
- Three-year warranty

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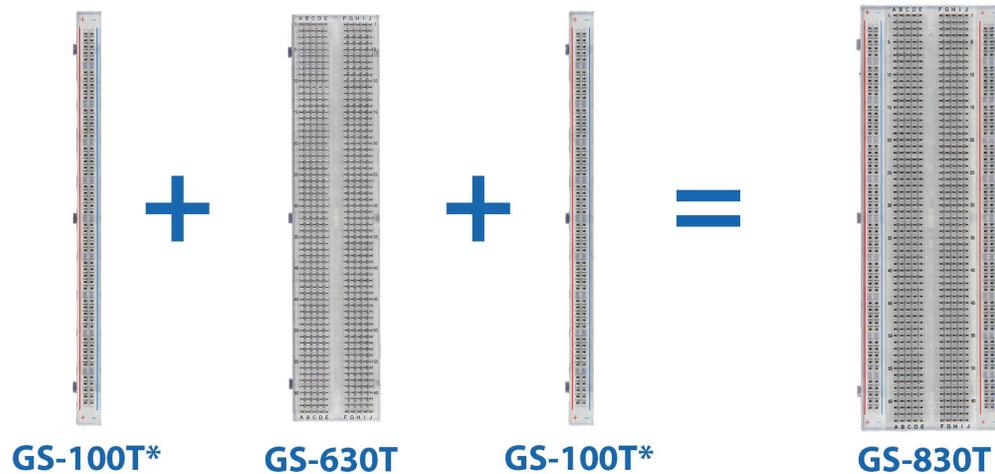
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### GS-830T Components



GS-100T\*

GS-630T

GS-100T\*

GS-830T

\*The GS-100T is sold as a pack of two